



Spread Spectrum Desktop/Notebook System Frequency Generator

Features

- Maximized EMI suppression using Cypress's Spread Spectrum technology
- Reduces measured EMI by as much as 10 dB
- I²C programmable to 153 MHz (16 selectable frequencies)
- Two skew-controlled copies of CPU output
- SEL100/66# selects CPU frequency (100 or 66.8 MHz)
- Seven copies of PCI output (synchronous w/CPU output)
- One copy of 14.31818-MHz IOAPIC output
- One copy of 48-MHz USB output
- Selectable 24-/48-MHz output is determined by resistor straps on power-up
- One high-drive output buffer that produces a copy of the 14.318-MHz reference
- Isolated core VDD pin for noise reduction

Key Specifications

Supply Voltages:..... $V_{DDQ3} = 3.3V \pm 5\%$
 $V_{DDQ2} = 2.5V \pm 5\%$

CPU Cycle to Cycle Jitter: 200 ps

CPU, PCI Output Edge Rate:..... ≥ 1 V/ns

CPU0:1 Output Skew: 175 ps

PCI_F, PCI1:6 Output Skew: 500 ps

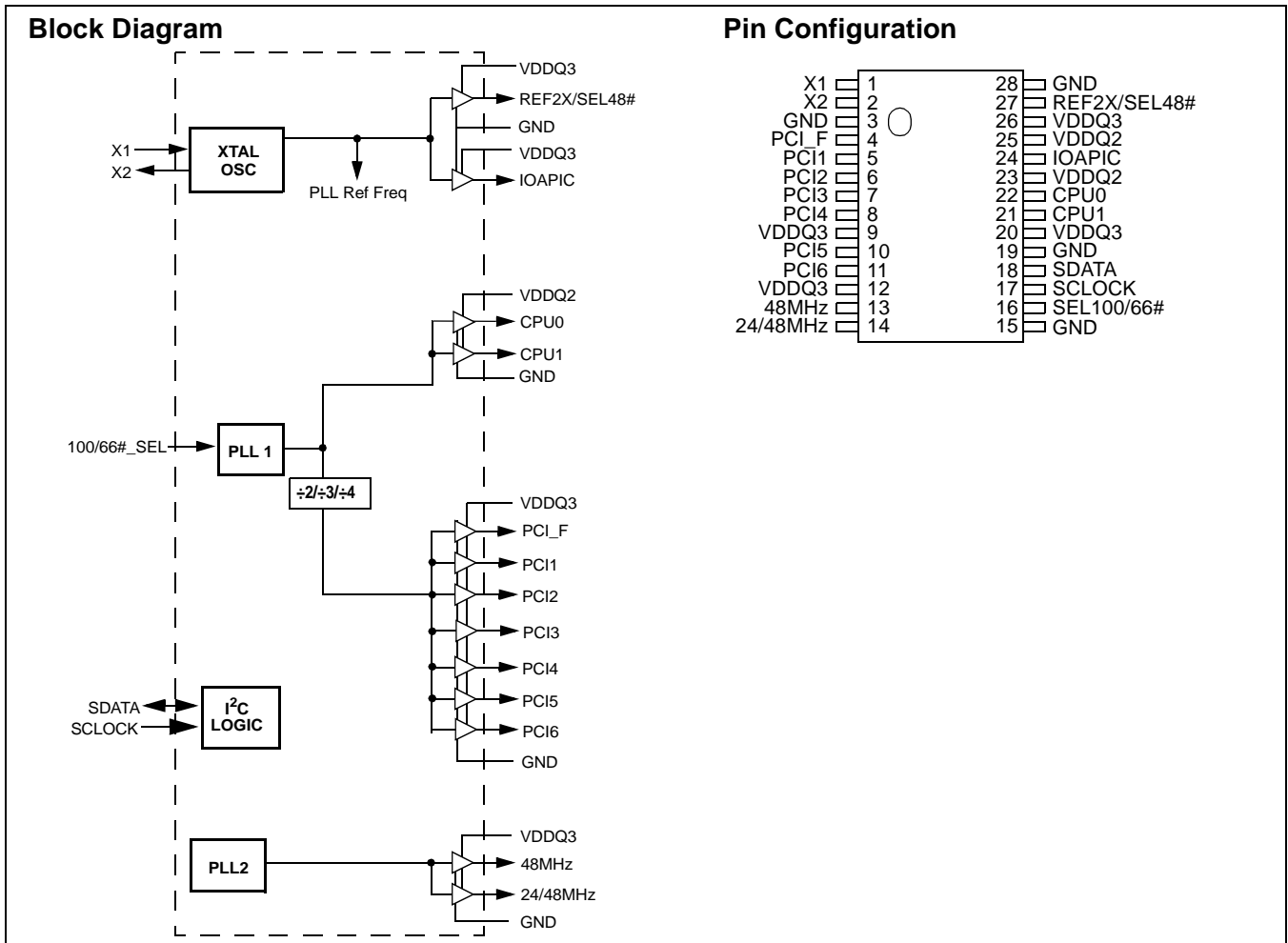
CPU to PCI Skew: 1 to 4 ns (CPU Leads)

REF2X/SEL48#, SCLOCK, SDATA..... 250-k Ω pull-up

Note: Internal pull-up resistors should not be relied upon for setting I/O pins HIGH.

Table 1. Pin Selectable Frequency

SEL100/66#	CPU(0:1)	PCI
1	100 MHz	33.3 MHz
0	66.8 MHz	33.4 MHz



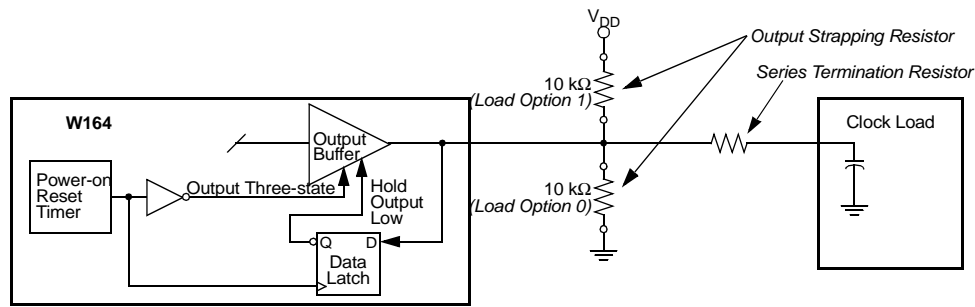


Figure 1. Input Logic Selection Through Resistor Load Option

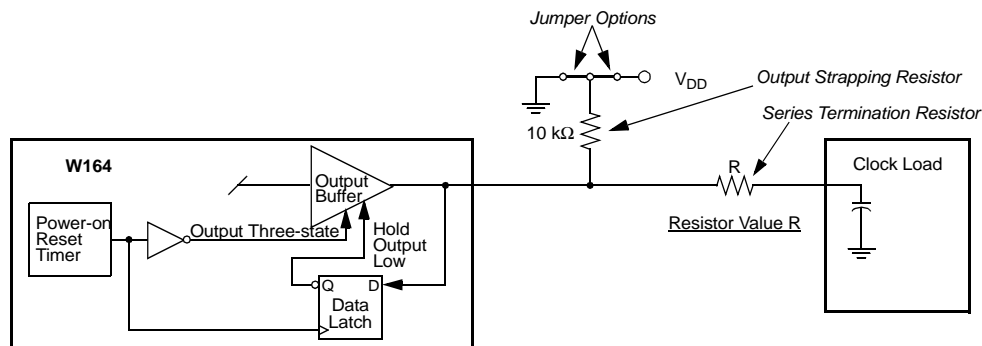


Figure 2. Input Logic Selection Through Jumper Option

Serial Data Interface

The W164 features a two-pin, serial data interface that can be used to configure internal register settings that control particular device functions. Upon power-up, the W164 initializes with default register settings. Therefore, the use of this serial data interface is optional. The serial interface is write-only (to the clock chip) and is the dedicated function of device pins SDATA and SCLOCK. In motherboard applications, SDATA and SCLOCK are typically driven by two logic outputs of the

chipset. Clock device register changes are normally made upon system initialization, if required. The interface can also be used during system operation for power management functions. *Table 2* summarizes the control functions of the serial data interface.

Operation

Data is written to the W164 in ten bytes of eight bits each. Bytes are written in the order shown in *Table 3*.

Table 2. Serial Data Interface Control Functions Summary

Control Function	Description	Common Application
Clock Output Disable	Any individual clock output(s) can be disabled. Disabled outputs are actively held LOW.	Unused outputs are disabled to reduce EMI and system power. Examples are clock outputs to unused PCI slots.
CPU Clock Frequency Selection	Provides CPU/PCI frequency selections beyond the 100- and 66.6-MHz selections that are provided by the SEL100/66# pin. Frequency is changed in a smooth and controlled fashion.	For alternate microprocessors and power management options. Smooth frequency transition allows CPU frequency change under normal system operation.
Output Three-state	Puts all clock outputs into a high-impedance state.	Production PCB testing.
Test Mode	All clock outputs toggle in relation to X1 input, internal PLL is bypassed. Refer to <i>Table 4</i> .	Production PCB testing.
(Reserved)	Reserved function for future device revision or production device testing.	No user application. Register bit must be written as 0.

Table 3. Byte Writing Sequence

Byte Sequence	Byte Name	Bit Sequence	Byte Description
1	Slave Address	11010010	Commands the W164 to accept the bits in Data Bytes 3–6 for internal register configuration. Since other devices may exist on the same common serial data bus, it is necessary to have a specific slave address for each potential receiver. The slave receiver address for the W164 is 11010010. Register setting will not be made if the Slave Address is not correct (or is for an alternate slave receiver).
2	Command Code	Don't Care	Unused by the W164, therefore bit values are ignored ("don't care"). This byte must be included in the data write sequence to maintain proper byte allocation. The Command Code Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus.
3	Byte Count	Don't Care	Unused by the W164, therefore bit values are ignored ("don't care"). This byte must be included in the data write sequence to maintain proper byte allocation. The Byte Count Byte is part of the standard serial communication protocol and may be used when writing to another addressed slave receiver on the serial data bus.
4	Data Byte 0	Don't Care	Refer to Cypress SDRAM drivers.
5	Data Byte 1		
6	Data Byte 2		
7	Data Byte 3	Refer to <i>Table 4</i>	The data bits in these bytes set internal W164 registers that control device operation. The data bits are only accepted when the Address Byte bit sequence is 11010010, as noted above. For description of bit control functions, refer to <i>Table 4</i> , Data Byte Serial Configuration Map.
8	Data Byte 4		
9	Data Byte 5		
10	Data Byte 6		

PCI Clock Outputs, PCI1:6 and PCI_F (Lump Capacitance Test Load = 30 pF)

Parameter	Description	Test Condition/Comments	CPU = 66.8/100 MHz			Unit
			Min.	Typ.	Max.	
t _P	Period	Measured on rising edge at 1.5V	30			ns
t _H	High Time	Duration of clock cycle above 2.4V	12			ns
t _L	Low Time	Duration of clock cycle below 0.4V	12			ns
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	1		4	V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	1		4	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
t _{JC}	Jitter, Cycle-to-Cycle	Measured on rising edge at 1.5V. Maximum difference of cycle time between two adjacent cycles.			250	ps
t _{SK}	Output Skew	Measured on rising edge at 1.5V			500	ps
t _O	CPU to PCI Clock Skew	Covers all CPU/PCI outputs. Measured on rising edge at 1.5V. CPU leads PCI output.	1		4	ns
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _O	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		20		Ω

IOAPIC Clock Output (Lump Capacitance Test Load = 20 pF)

Parameter	Description	Test Condition/Comments	CPU = 66.8/100 MHz			Unit
			Min.	Typ.	Max.	
f	Frequency, Actual	Frequency generated by crystal oscillator	14.31818			MHz
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.0V	1		4	V/ns
t _F	Output Fall Edge Rate	Measured from 2.0V to 0.4V	1		4	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.25V	45		55	%
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			1.5	ms
Z _O	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		15		Ω

REF2X Clock Output (Lump Capacitance Test Load = 20 pF)

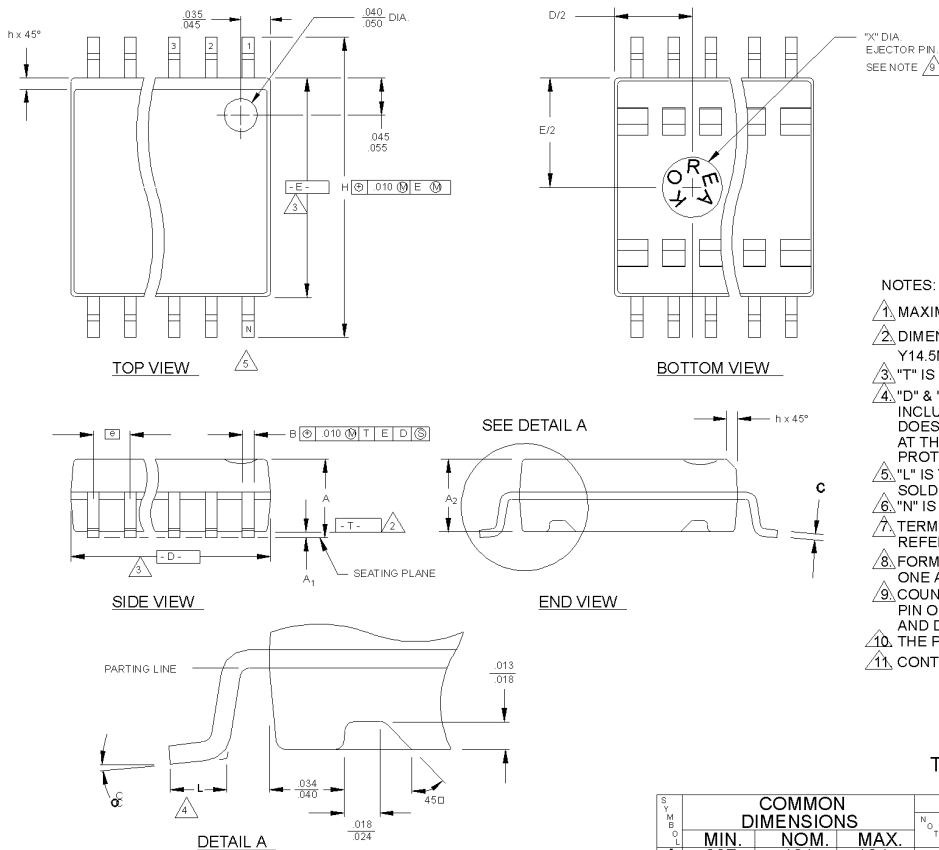
Parameter	Description	Test Condition/Comments	CPU = 66.8/100 MHz			Unit
			Min.	Typ.	Max.	
f	Frequency, Actual	Frequency generated by crystal oscillator	14.318			MHz
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	0.5		2	V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	0.5		2	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _O	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		15		Ω

48-MHz and 24-MHz Clock Output (Lump Capacitance Test Load = 20 pF)

Parameter	Description	Test Condition/Comments	CPU = 66.8/100 MHz			
			Min.	Typ.	Max.	Unit
f	Frequency, Actual	Determined by PLL divider ratio (see m/n below)	48.008 24.004			MHz
f _D	Deviation from 48 MHz	(48.008 – 48)/48	+167			ppm
m/n	PLL Ratio	(14.31818 MHz x 57/17 = 48.008 MHz)	57/17, 57/34			
t _R	Output Rise Edge Rate	Measured from 0.4V to 2.4V	0.5		2	V/ns
t _F	Output Fall Edge Rate	Measured from 2.4V to 0.4V	0.5		2	V/ns
t _D	Duty Cycle	Measured on rising and falling edge at 1.5V	45		55	%
f _{ST}	Frequency Stabilization from Power-up (cold start)	Assumes full supply voltage reached within 1 ms from power-up. Short cycles exist prior to frequency stabilization.			3	ms
Z _o	AC Output Impedance	Average value during switching transition. Used for determining series termination value.		25		Ω

Ordering Information

Ordering Code	Package Name	Package Type
W164	G	28-pin SOIC (300 mils)

Package Diagram
28-Pin Small Outline Integrated Circuit (SOIC, 300 mils)

NOTES:

1. MAXIMUM DIE THICKNESS ALLOWABLE IS .025.
2. DIMENSIONING & TOLERANCES PER ANSI Y14.5M - 1982.
3. "T" IS A REFERENCE DATUM.
4. "D" & "E" ARE REFERENCE DATUMS AND DO NOT INCLUDE MOLD FLASH OR PROTRUSIONS, BUT DOES INCLUDE MOLD MISMATCH AND ARE MEASURED AT THE MOLD PARTING LINE. MOLD FLASH OR PROTRUSIONS SHALL NOT EXCEED 0.006 INCHES PER SIDE.
5. "L" IS THE LENGTH OF TERMINAL FOR SOLDERING TO A SUBSTRATE.
6. "N" IS THE NUMBER OF TERMINAL POSITIONS.
7. TERMINAL POSITIONS ARE SHOWN FOR REFERENCE ONLY.
8. FORMED LEADS SHALL BE PLANAR WITH RESPECT TO ONE ANOTHER WITHIN .003 INCHES AT SEATING PLANE.
9. COUNTRY OF ORIGIN LOCATION AND EJECTOR PIN ON PACKAGE BOTTOM IS OPTIONAL AND DEPEND ON ASSEMBLY LOCATION.
10. THE POCKETS ON THE BOTTOM ARE OPTIONAL.
11. CONTROLLING DIMENSION: INCHES.

THIS TABLE IN INCHES

SYMBOL	COMMON DIMENSIONS			NOTE VARIATIONS	3			5
	MIN.	NOM.	MAX.		D			
A	.097	.101	.104	AA	.402	.407	.412	16
A ₁	.0050	.009	.0115	AB	.451	.456	.461	18
A ₂	.090	.092	.094	AC	.500	.505	.510	20
B	.014	.016	.019	AD	.602	.607	.612	24
C	.0091	.010	.0125	AE	.701	.706	.711	28
D	SEE VARIATIONS			3				
E	.292	.296	.299					
e	.050 BSC							
H	.400	.406	.410					
h	.010	.013	.016					
L	.024	.032	.040					
N	SEE VARIATIONS			5				
OC	0°	5°	8°					
X	.085	.093	.100					

THIS TABLE IN MILLIMETERS

SYMBOL	COMMON DIMENSIONS			NOTE VARIATIONS	3			5
	MIN.	NOM.	MAX.		D			
A	2.46	2.56	2.64	AA	10.21	10.34	10.46	16
A ₁	0.127	0.22	0.29	AB	11.46	11.58	11.71	18
A ₂	2.29	2.34	2.39	AC	12.70	12.83	12.95	20
B	0.35	0.41	0.48	AD	15.29	15.42	15.54	24
C	0.23	0.25	0.32	AE	17.81	17.93	18.06	28
D	SEE VARIATIONS			3				
E	7.42	7.52	7.59					
e	1.27 BSC							
H	10.16	10.31	10.41					
h	0.25	0.33	0.41					
L	0.61	0.81	1.02					
N	SEE VARIATIONS			5				
OC	0°	5°	8°					
X	2.16	2.36	2.54					

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Document Number: 38-07169

REV.	ECN NO.	Issue Date	Orig. of Change	Description of Change
**	110279	11/05/01	SZV	Change from Spec number: 38-00841 to 38-07169
*A	122810	12/15/02	RBI	Add Power up Requirements to Operating Conditions Information